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(12) **United States Design Patent**
Lee

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(54) **THERMO ELECTRIC HEAT TRANSFER SYSTEM**

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(**) Term: **14 Years**

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(51) **LOC (9) Cl.** **13-03**

(52) **U.S. Cl.** **D13/179**

(58) **Field of Classification Search** D13/179;
165/80.3, 104.33, 151, 122, 185; 257/706,
257/707, 718-722; 361/687, 695, 697, 700,
361/702, 704, 709, 710, 711, 719

See application file for complete search history.

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Robert Johnson

(57) **CLAIM**

I claim the ornamental design for a thermo electric heat transfer system, as shown and described.

DESCRIPTION

FIG. 1 is an isometric perspective view of this invention in a heat transfer mode.

FIG. 2 is a front elevation thereof.

FIG. 3 is a side elevation thereof.

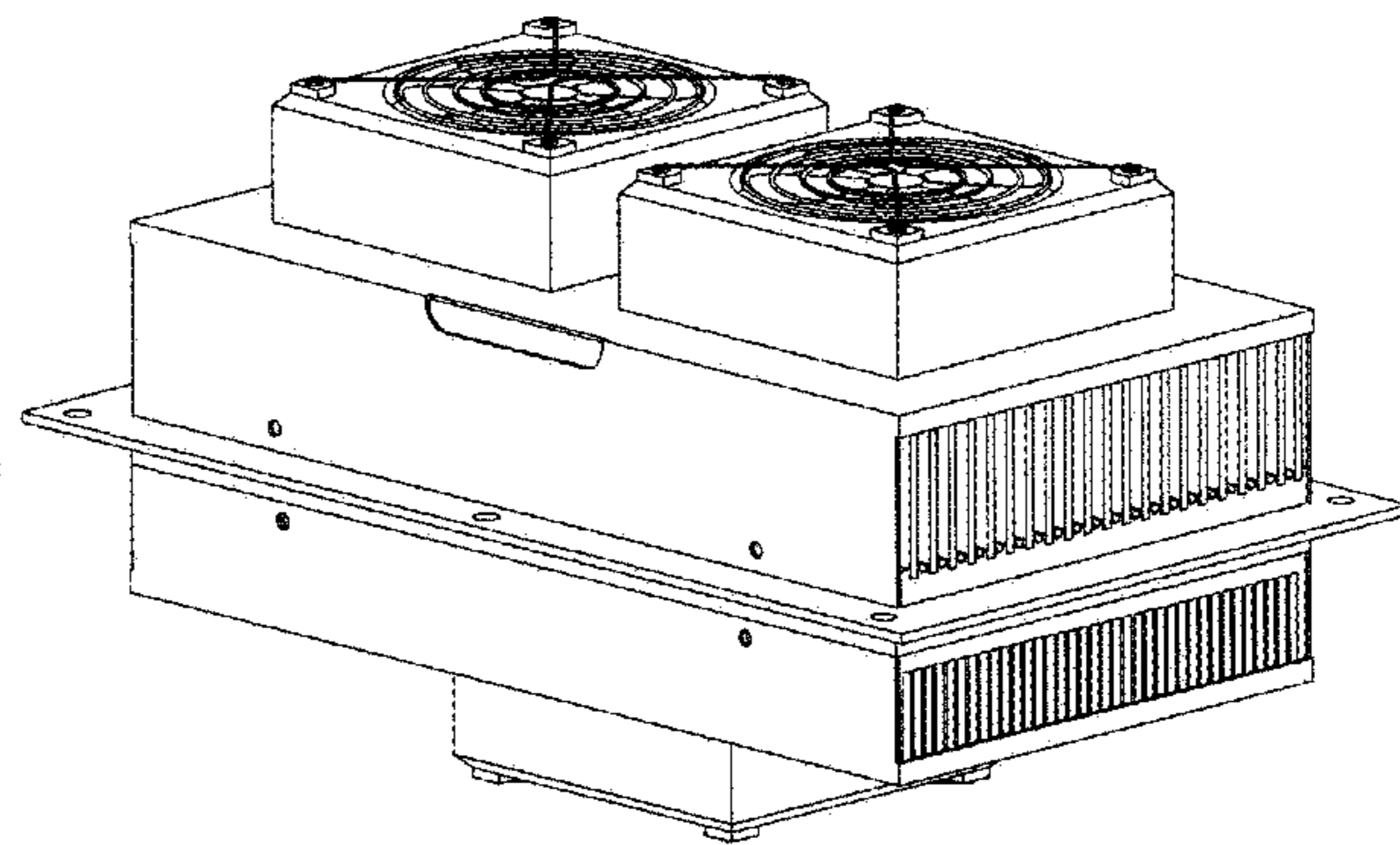
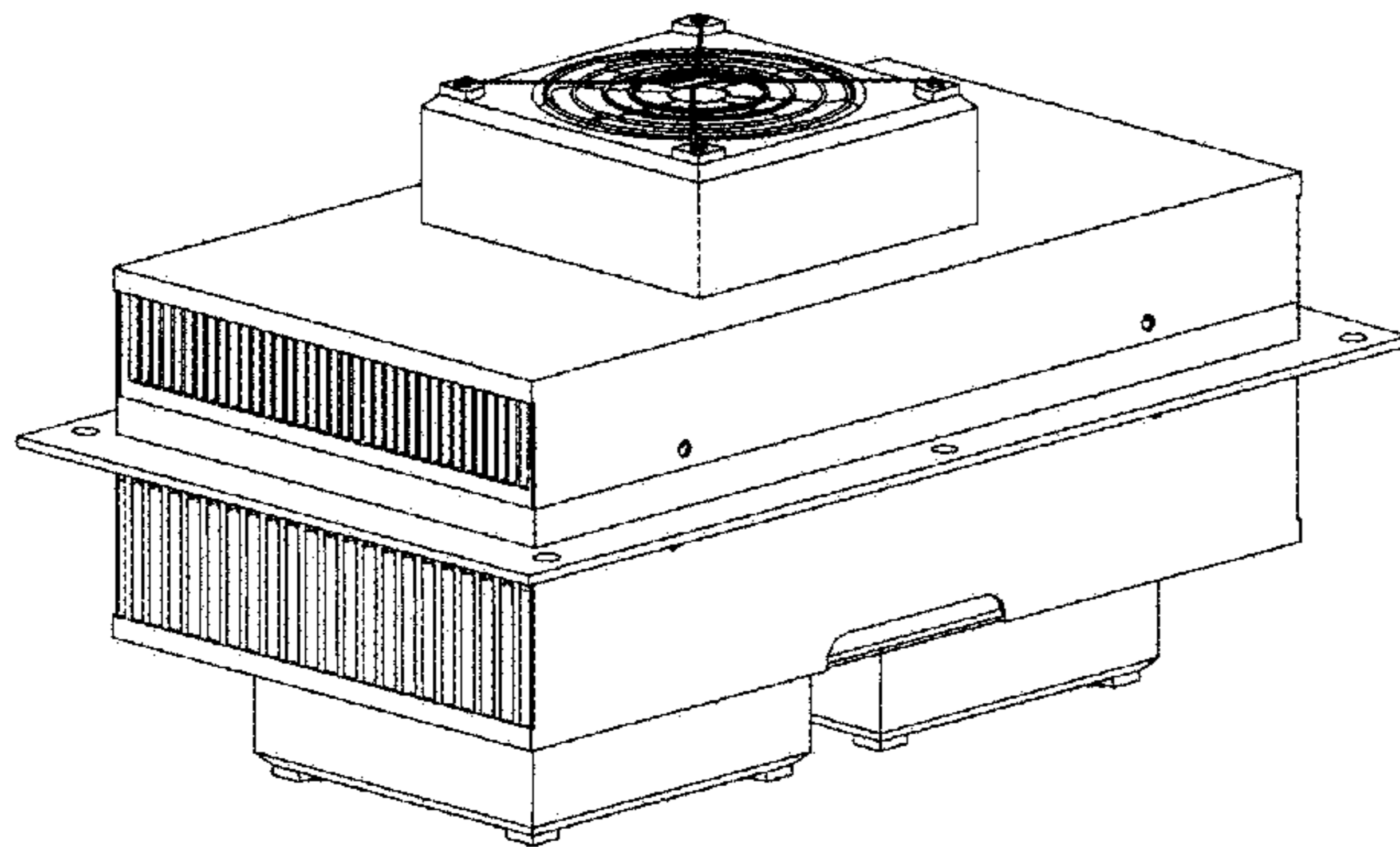
FIG. 4 is an isometric perspective view of this invention in a cooling (Reverse Heat Transfer) mode to that of FIG. 1.

FIG. 5 is bottom plan of FIG. 4

FIG. 6 is top plan thereof; and,

FIG. 7 is an exploded view of FIG. 4.

1 Claim, 7 Drawing Sheets



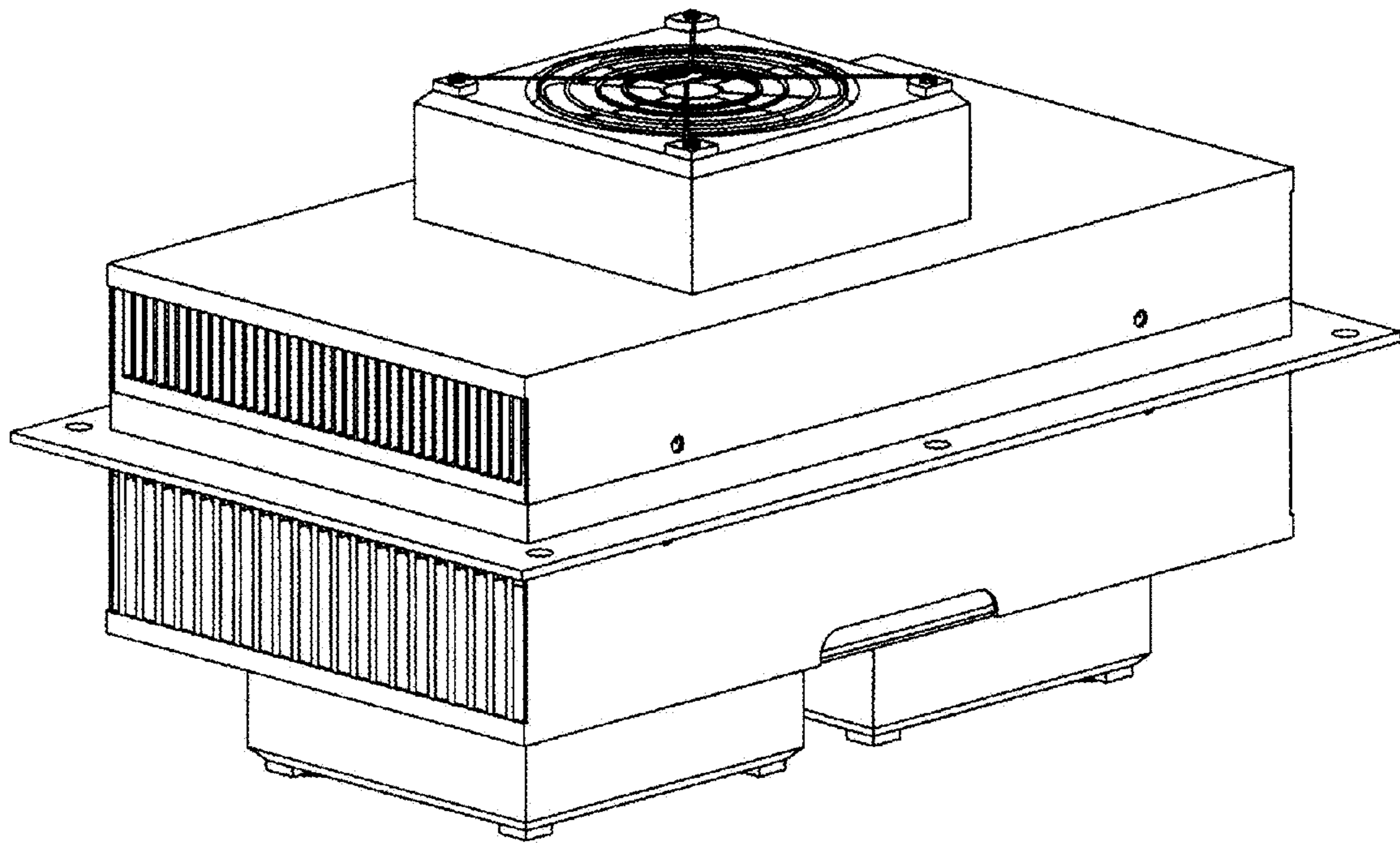


FIG. - 1

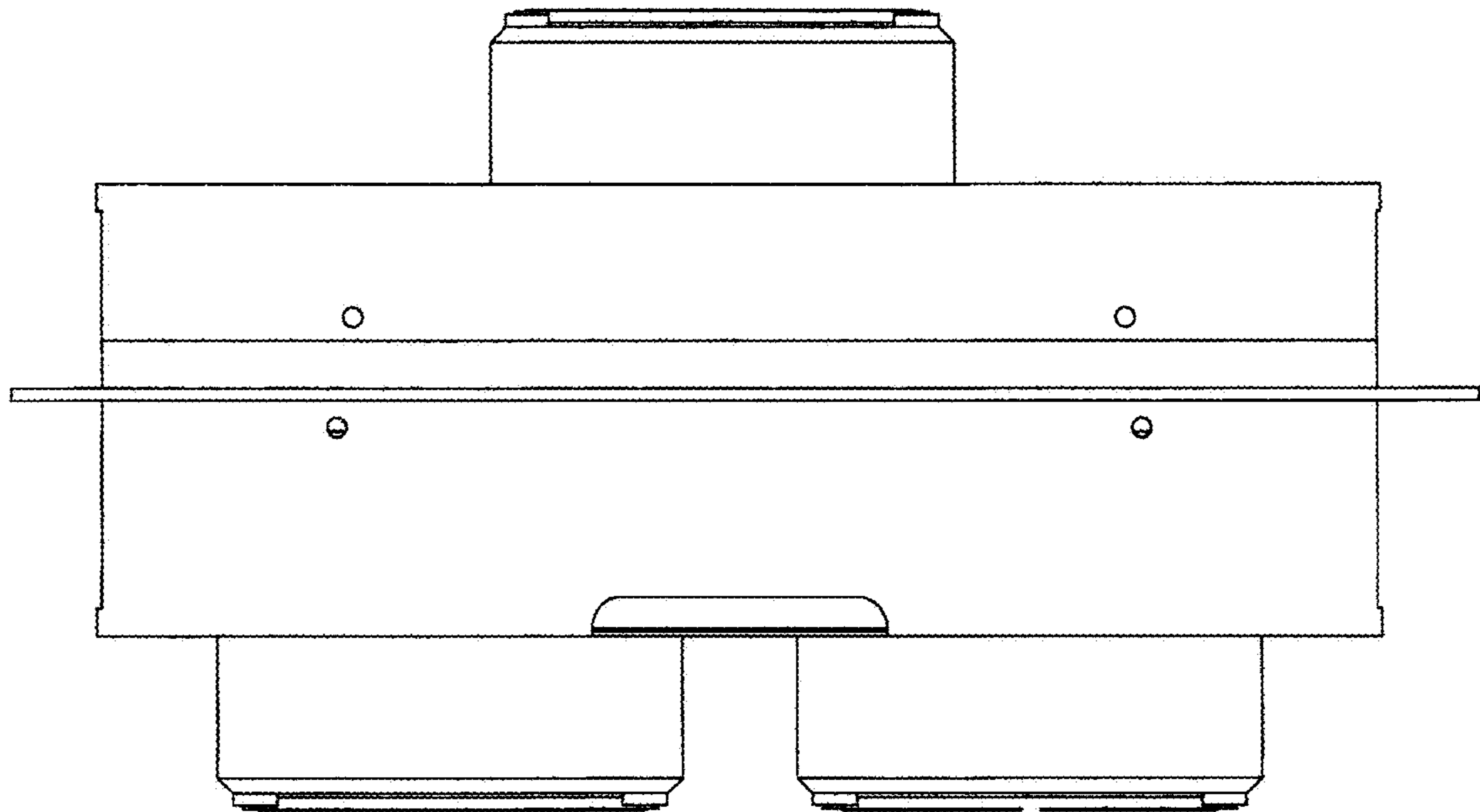


FIG. - 2

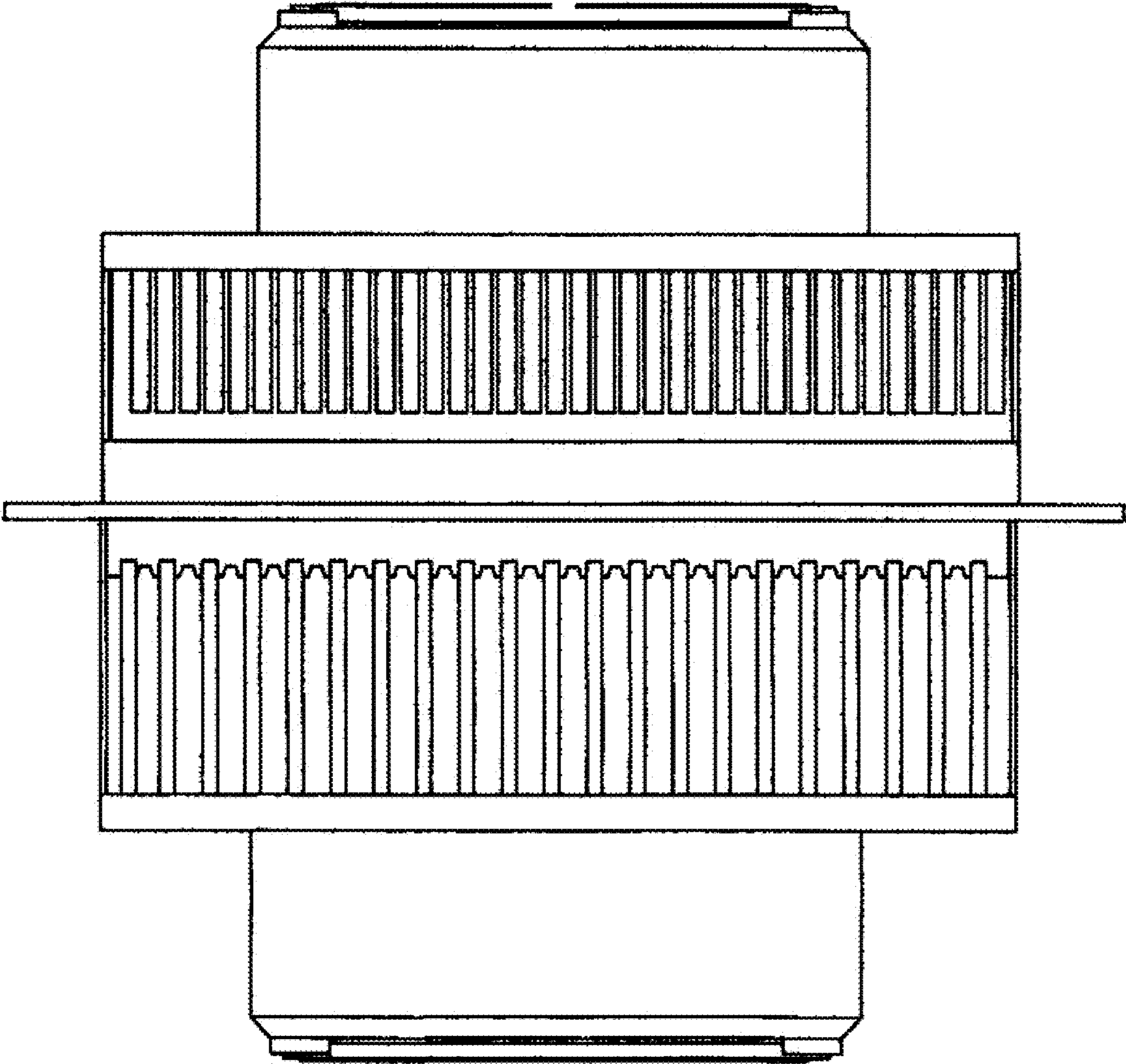


FIG.- 3

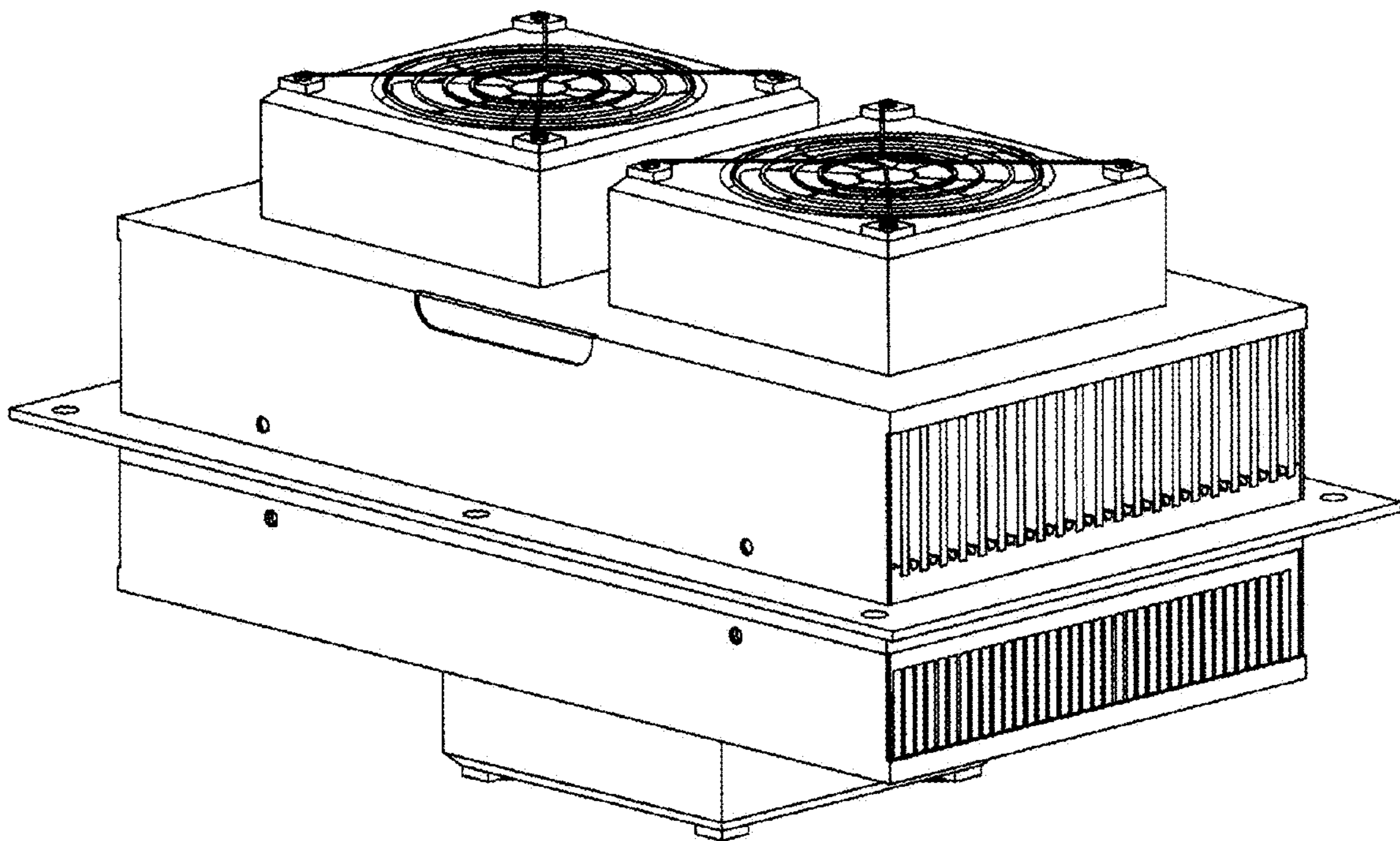


FIG. - 4

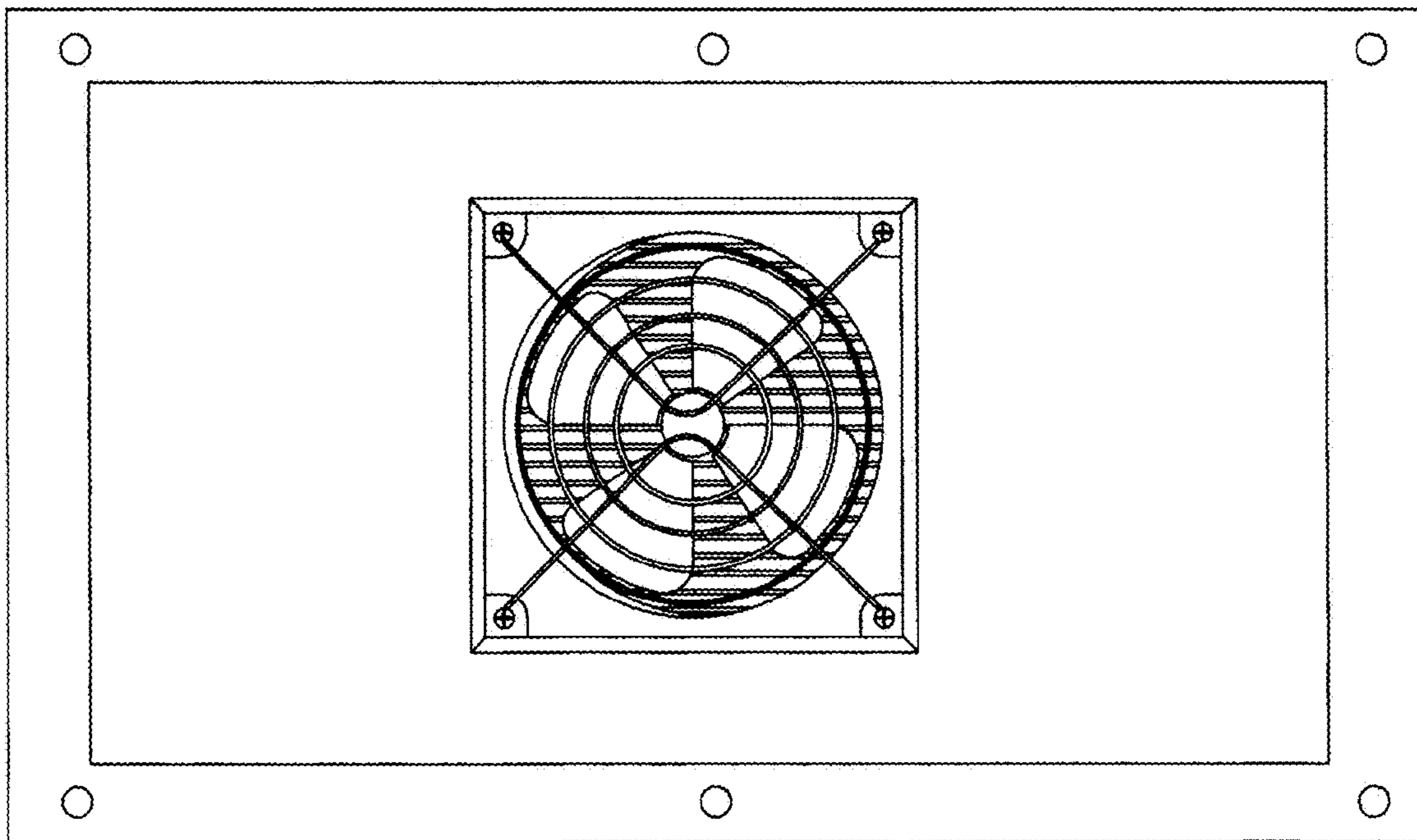


FIG. - 5

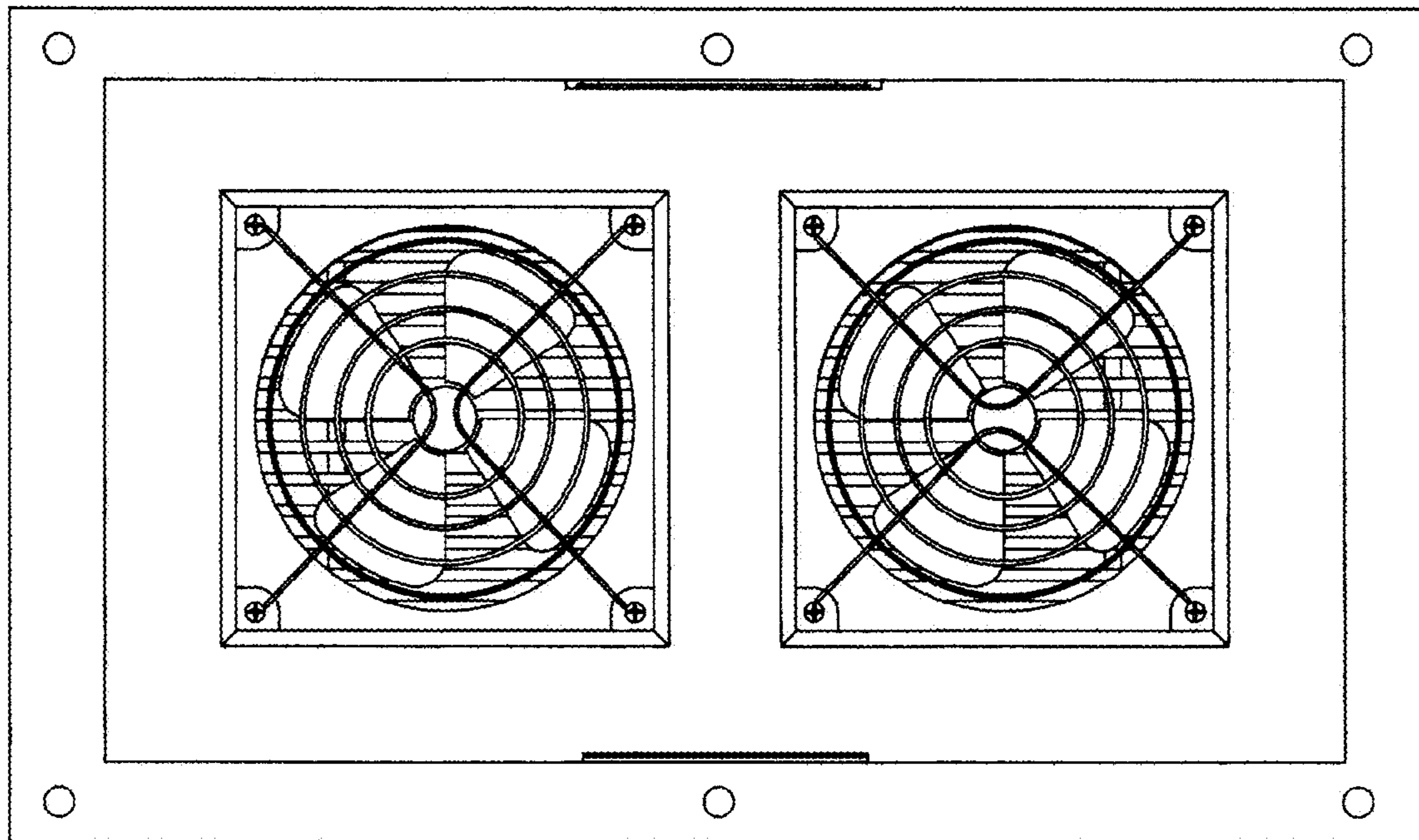


FIG. - 6

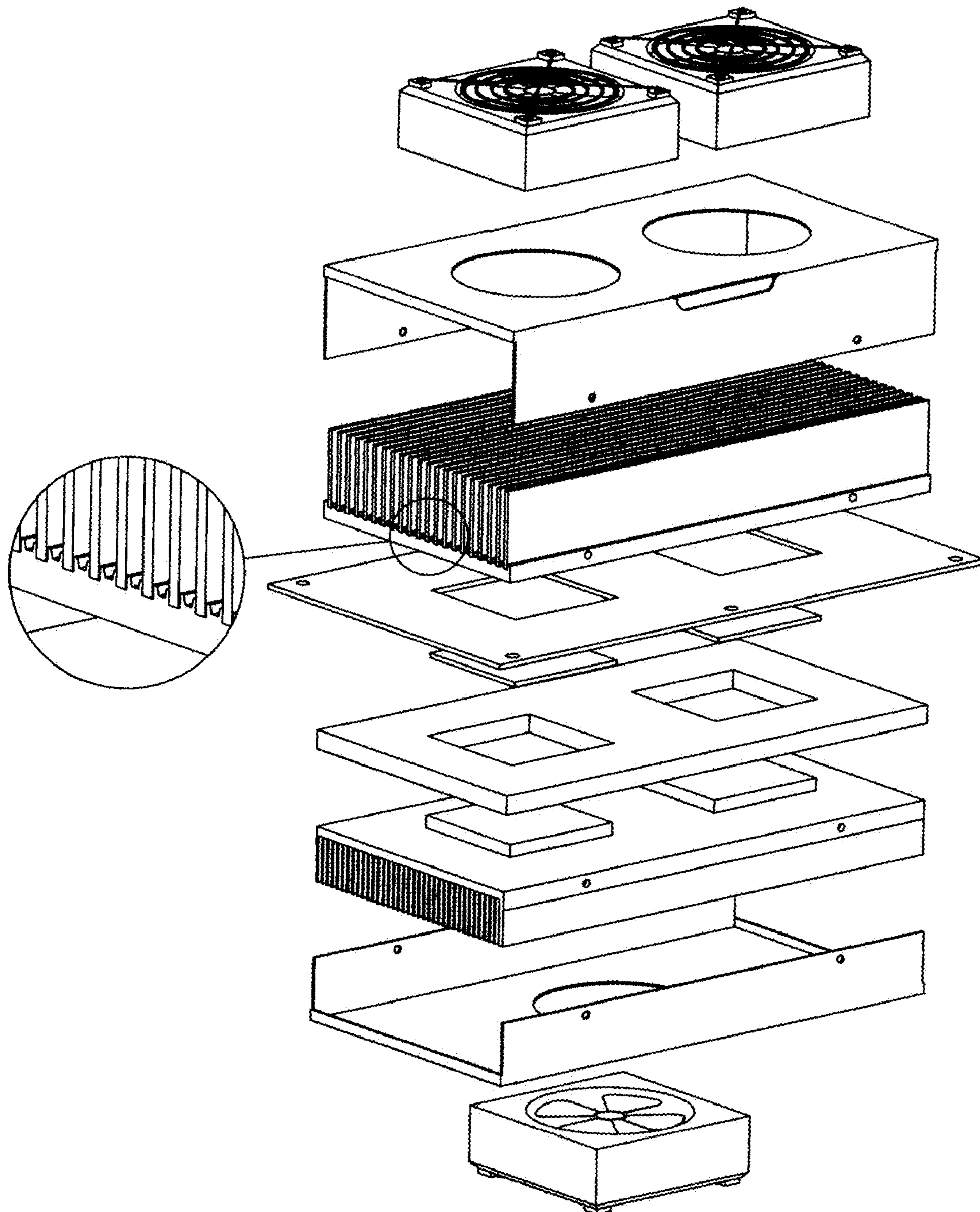


FIG. - 7